

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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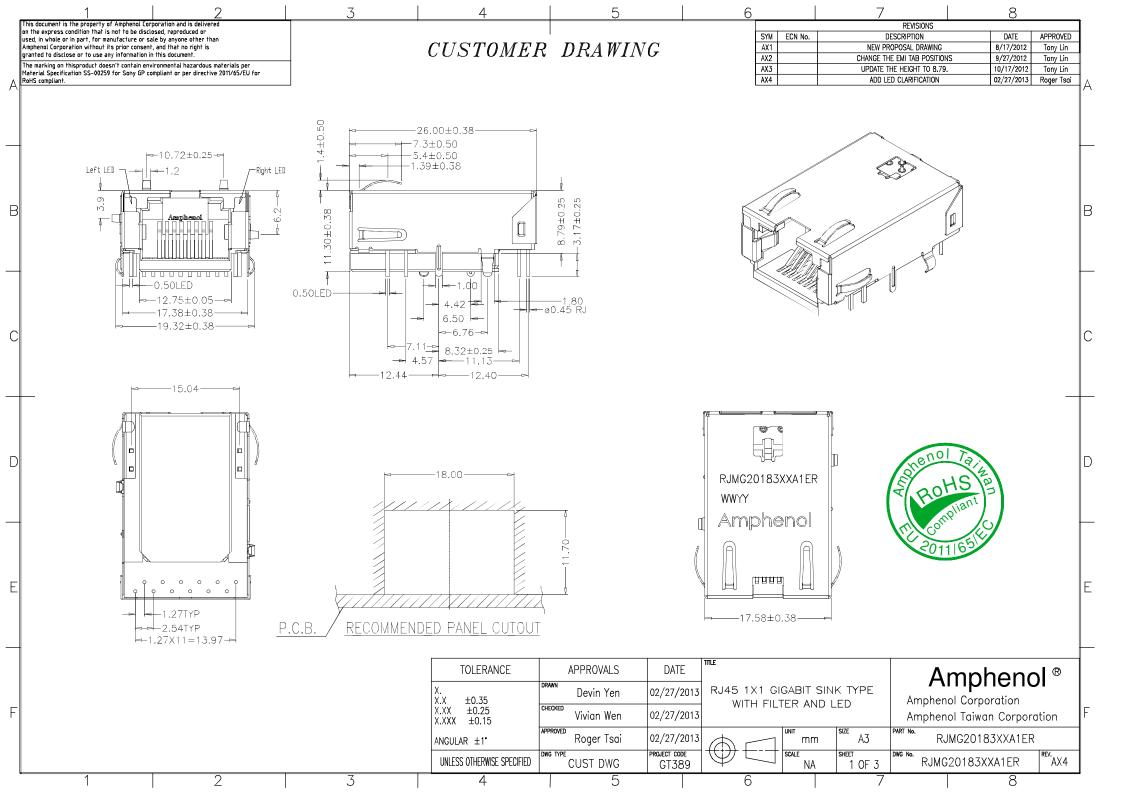
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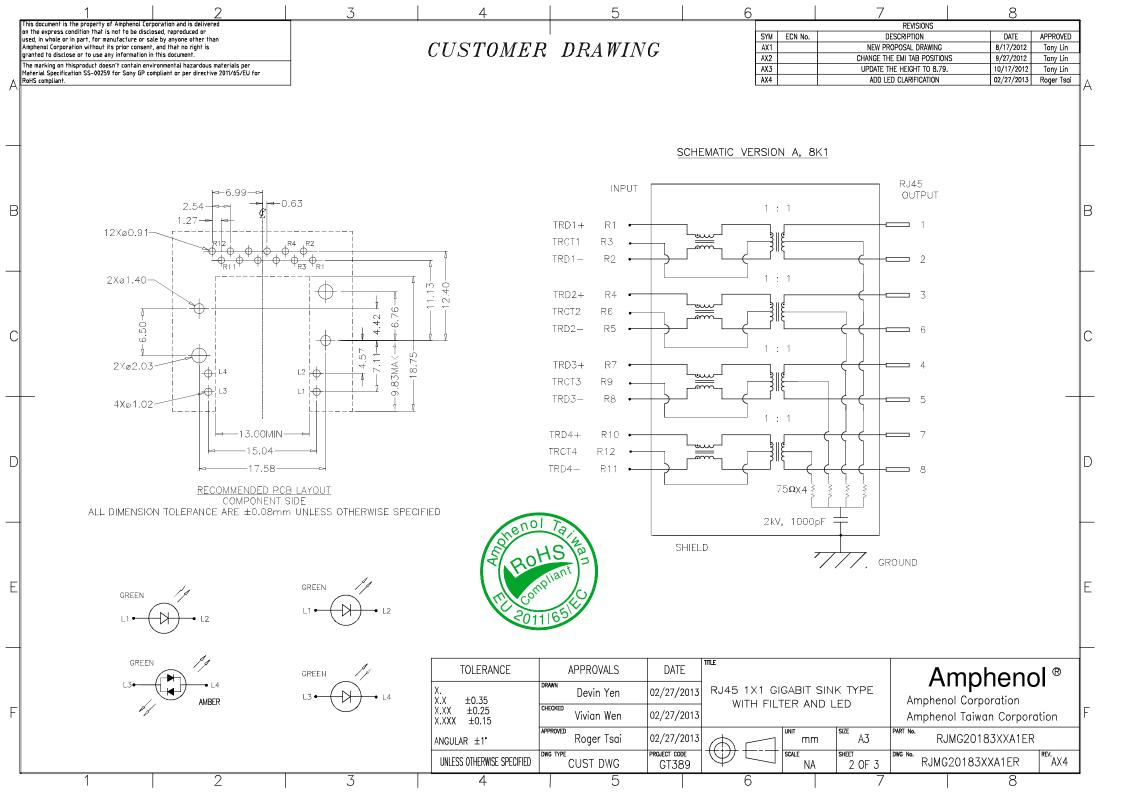
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	MATERIALS: ELECTRICAL SPECIFICATION(@25° C)									
В	1.Terminal Parts:		CONNECTOR PERFORMANCE							
٥	·	RJ Terminal :Phosphor Bronze,Thickness=0.30mm Finish:30u" gold on contact area.		LED PERFORMANCE SINGLE COLOUR BICOLOUR			PARAMETER	LIMITS (MAX. OR MIN.)	FREQUENCY RANGE/	В
	1.2.RJ input Terminal :Phosphor Br	onze, Diameter 0.45mm	PARAMETER	GREEN	GREEN AMBER		INSERTION LOSS (RX/TX)	-1.0dB MAX.	TEST CONDITIONS	
	Finish:100u" min. tin over 50° 100u" min. matte tin plating o		FORWARD CURRENT IF MAX REVERSE CURRENT IR MAX REVERSE VOLTAGE VR MAX	20 10 -5	10 -5	mA uA V	RETURN LOSS (RX/TX)	-18dB MIN. -16dB MIN. -12dB MIN.	1-30 MHz 30-60 MHz 60-80 MHz	
	1.3.Module Terminal : Phosphor Bro Finish:100u" min. tin over 50		T OPERATURE	-40~+85	-40~+85	٤	CM-CM REJECTION	-10dB MIN. -30dB MIN.	80-100 MHz 1-100 MHz	C
	2.Plastic Parts:	TOOU NICKEI.	T SOLDERING POWER DISS. Pd	260+/-5 70	260+/-5 70	ځ mW	CROSSTALK ISOLATIC (RX/TX)	N -30dB MIN.	1-100 MHz	
	2.1.Housing : High temp. Thermople		PEAK WAVELENTH	565	565 605	nM	HIPOT (ISOLATION)	1.5kVrms MIN. 350uH MIN.	60S 100KHz 100mV 8mA	
_	Flame Class:UL94 V— 2.2.Coil Case : High temp. Thermos		FORWARD VOLTAGE TYP FORWARD VOLTAGE MAX	2.2	2.2 2.2 2.5 2.5	(@IF=20mA) V (@IF=20mA)	TURN RATIO	1:1±5%	TOURIZ TOURIN GILL	
D	Flame Class:UL94 V-0 3.Shell Parts: 3.1.Shell: Stainless Steel,Thickness=0.20mm, Grounding Leg: Pre-soldering. OTHERS: 1.Operating Temperature: 0°C TO +70°C 2.Storage Temperature: -40°C TO +85°C 3.WAVE SOLDERING TEMPRATURE: 265 DEG.C 10 SEC MAX 4.JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F		RJMG20183 X X A1ER LED1 (RIGHT SIDE) O- No LED (Blocked Hole) 1- Green P- Bi color Green/Amber O- No LED (Blocked Hole) 1- Green O- No LED (Blocked Hole) 1- Green							
F	TART OU, SODIARTI	TOLERANCE APPROVALS DATE X.							ration F	
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